

Title (en)

METHOD AND SYSTEM FOR PRODUCING CIRCUIT BOARDS

Title (de)

VERFAHREN UND SYSTEM ZUR HERSTELLUNG VON LEITERPLATTEN

Title (fr)

PROCÉDÉ ET SYSTÈME POUR FABRIQUER DES CARTES DE CIRCUITS IMPRIMÉS

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Application

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Abstract (en)

[origin: WO2013068054A1] The invention relates to a method and to a system (1) for producing circuit boards (2) having pressed-in moulded parts, wherein at least one moulded part (3), before being pressed into a cutout (4) in a circuit board (2) by means of a pressing tool (6), is oriented by a template (7) relative to the cutout (4) in the circuit board (2).

IPC 8 full level

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